

1. INTRODUCTION

The purpose of this application note is to describe the implementation of a PCI bus master 100 Base-TX Fast Ethernet node using MXIC's highly integrated single chip Fast Ethernet NIC controller MX98725. In details, this document presents product overview, programming guide, hardware design and layout recommendations that can help you to quickly and smoothly implement a Fast Ethernet adapter card.

As you can find in the MX98725 driver diskette, MXIC

already provided a complete set of high quality drivers for easier and more efficient way to interface with MX98725 on the most popular Network Operating Systems. Nevertheless, there are still some special applications or environment not covered in the MX98725 driver diskette. Driver developers, however, could still refer to the section of driver programming guide to accomplish the required driver. It is recommended that you are familiar with the MX98725 data sheet before reading this guide.

2. PRODUCT OVERVIEW

The MX98725 implements the 10/100Mbps MAC layer and Physical layer on a single chip in accordance with the IEEE 802.3 standard.

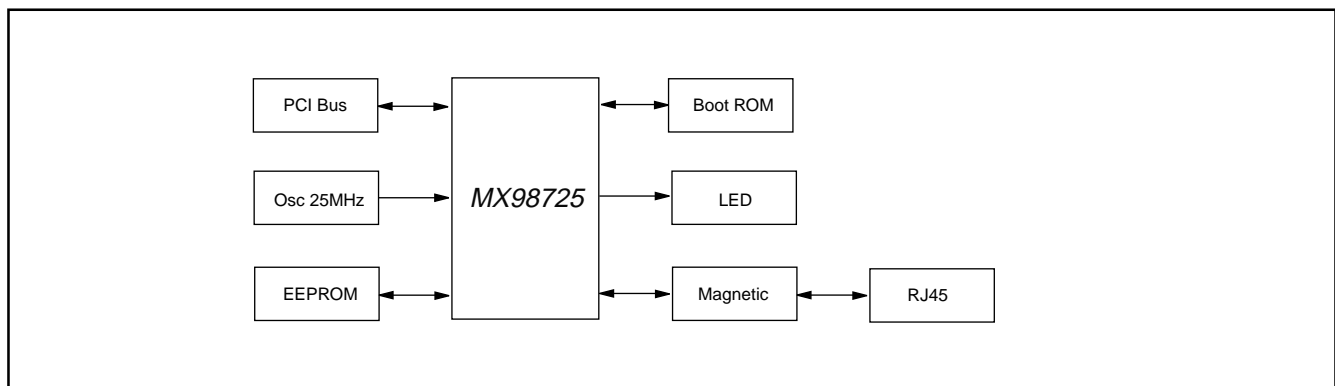
The MX98725 highly integrates with direct PCI bus interface, including PCI bus master with DMA channel capability, direct EEPROM as well as Boot ROM interface, and large on chip transmit/receive FIFOs. Also, the MX98725

is equipped with intelligent IEEE802.3u-compliant Nway auto-negotiation capability allowing a single RJ-45 connector to link with the other IEEE802.3u-compliant device without re-configuration. To optimize operating bandwidth, network data integrity and throughput, the proprietary Adaptive Network Throughput Control (ANTC) function is implemented. For detailed product specification information, please refer to the MX98725 data sheet.

3. HARDWARE DESIGN CONSIDERATIONS

3.1 SYSTEM APPLICATION BLOCK DIAGRAM

A system block diagram for the MX98725 based Fast Ethernet adapter card is shown as following:



3.2 PCI CONNECTION

The MX98725 provides direct PCI bus interface to PCI connector. Board designers should especially take care of the four pins of TDI, TDO, PRSNT1# & PRSNT2# that are only related to PCI bus connector. Boards that do not implement JTAG Boundary Scan should tight TDI and TDO together to prevent the scan chain from being broken.

Both pins PRSNT1# and PRSNT2# should be connected to ground indicating that the board is physically presenting in a PCI slot and providing information about the total power requirements (less than 7.5W) of the board.

3.3 OSCILLATOR

The MX98725 is designed to operate with a 25MHz-oscillator module. The clock specification of this oscillator should meet 25MHz +/- 50PPM.

Furthermore, if flash memory is used, one can change its contents via CSR9 and CSR10 (Refer to MX98725 data sheet).

Detailed software programming example is described in section 4.6.

3.4 BOOT ROM

The MX98725 supports a direct boot ROM interfaces allowing diskless workstations to remotely download operating system from network server. For proper operation, the access time of adapted EPROM should not excess 240ns.

Furthermore, if flash memory is used, user could easily change its contents via CSR9 and CSR10. Detailed information of CSR9 and CSR10 please refer to MX98725 data sheet. In Section 4.6, an example of flash memory programming methods is listed.

3.5 SERIAL EEPROM

The MX98725 provides pins EECS, BPA0 (EECK), BPA1 (EEDI) and BPD0 (EEDO) for directly accessing the serial EEPROM. BPA0-1 and BPD0 serve as SK (EECK), DI (EEDI) and DO (EEDO) respectively. The contents of the EEPROM include the ID information of the MX98725 (VendorID, DeviceID, Sub-vendorID, Sub-deviceID and MAC ID), and the configuration parameters for software driver. The EEPROM contents should be programmed according to MXIC' definition as mentioned in Appendix

A. Detailed software programming example is described in section 4.5.

3.6 PROGRAMMABLE LED SUPPORT

The MX98725 provides four pins LED0SEL, LED1SEL, LED2SEL and LED3SEL to control display LED. Displayed messages are programmable through setting CSR9 bit 28~31 to serve as Activity or Linkspeed, Goodlink or Link/Activity, TX or Collision and RX or Full/Half Duplex LED respectively. The maximum sinking current of these output pins is 16mA. Current limiting resistor (560Ω) should be added to ensure proper operation. The following indicates the configuration setting example table for LED display programming.

CSR9 <28:31>	LED0	LED1	LED2	LED3
0000	Activity	Goodlink	TX	RX
1111	Linkspeed	Link/Act	Collision	F/H duplex

3.7 NETWORK INTERFACE TO MAGNETIC COMPONENT

For isolating and impedance matching purpose, an isolating transformer with 1:1 transmit and 1:1 receive turns ratio is required for transmit and receive twisted pair interface. In Appendix B, several transformers that we had verified successfully with MX98725 are listed for quick reference purpose.

3.8 OPTIMIZED EQUALIZER COMPONENTS

MXIC' Fast Ethernet solution utilizes adaptive equalizer to compensate the attenuation and phase distortion induced by different lengths of cable. To optimize transmit and receive signal quality, pins RTX and RTX2EQ should be connected to external resistors 560Ω (±1%) and 1.4KΩ (±1%) and then to ground respectively.

3.9 Remote-Power-On and ACPI application

MX98725 fully supports Remote-Power-On and ACPI that meets PC98 requirement for power-sensitive applications. To implement such advance features, two necessary conditions should be met at first:

- (1) After the AC power being plugged in, power supply must be continuously drained at least 400mA from auxiliary power, no matter the switch is in ON or OFF states.
- (2) Motherboard BIOS must support Remote-Power-On.

The auxiliary power and PCI bus power are decoupled via a power switch (FDC6324L). After the AC power core being plugged in, the MX98725 will automatically load network ID from EEPROM and begin to scan incoming packet. Once receiving magic packet from network, PMEB and EXTSTARTB of MX98725 will be asserted low and LANWAKE will be asserted high to wake up the host.

PMEB will be asserted when one of the following conditions meet:

- (1) The MX98725 is in D1 state, PMCSR<8> and PMEB enable, and a magic packet is received.
- (2) The MX98725 is in D3-cold (power off) state, and a magic packet is received.

PMEB can be disserted by:

- (1) Clearing PMCSR<8>
- (2) Writing 1 to PMCSR<15>
- (3) Turn on the host power

4. DRIVER PROGRAMMING GUIDE

This chapter will provide you the necessary information for programming driver for the MX98725 based node. Initialization module is introduced first that describes how MX98725 is initialized before any other operations can commence, then followed by actual implementation examples for both transmit and receive operations. Programming differences between MX98713, MX98713A and MX98725 are also included that will help you to upgrade your own driver to support all MXIC' NIC product series.

4.1 INITIALIZATION

```

initializeTheTransmitRing()
{
    unsigned int    i,j;
    unsigned long   physicaladdress;
    for (i=0; i<NumTXBuffers; i++) {
        /* memory allocation for tx descriptor_buffer (align 4) */
        tx_resource[i]=
            (struct TX_RESOURCE *)((((unsigned int)tx_temp[i])+4)&
0xffffc);
    }

    for (i=0; i<NumTXBuffers; i++) {
        /* initialize the own bit to host tdes0 */
        tx_resource[i]->ownership=0x00;
        tx_resource[i]->tstatus=0x0000;
        tx_resource[i]->tdes0_unused=0x00;

        /* fill buffer_1_address tdes2 */
        get_ea((void far *) (tx_resource[i]->tx_buffer_data),

```

```

        &physicaladdress);
        tx_resource[i]->buff_1_addr=physicaladdress;

        /* fill buffer_2_address tdes3 */
        if (i==NumTXBuffers-1) j=0;
        else j=i+1;
        get_ea((void far *) (tx_resource[j], &physicaladdress);
        tx_resource[i]->buff_2_addr=physicaladdress;
    }
}

initializeTheReceiveRing()
{
    unsigned int    i,j;
    unsigned long   physicaladdress;
    for (i=0; i<NumRXBuffers; i++) {
        /* memory allocation for rx descriptor_buffer (align 4) */
        rx_resource[i]=
            (struct RX_RESOURCE *)((((unsigned int)rx_temp[i])+4)&
0xffffc);
    }

    for (i=0; i<NumRXBuffers; i++) {
        /* set the own bit to chip rdes0 */
        rx_resource[i]->frame_length=RDES0_OWN_BIT;
        rx_resource[i]->rstatus=0x0000;

        /* fill rdes1 */
        rx_resource[i]->command=RDES1_BUFFER-
RX_BUFFER_SIZE+rxpkt_size[i];

        /* fill buffer_1_address rdes2 */
        get_ea((void far *) (rx_resource[i]->rx_buffer_data),
            &physicaladdress);
        rx_resource[i]->buff_1_addr=physicaladdress;
        /* fill buffer_2_address rdes3 */
        if (i==NumRXBuffers-1) j=0;
        else j=i+1;
        get_ea((void far *) (rx_resource[j], &physicaladdress);
        rx_resource[i]->buff_2_addr=physicaladdress;
    }
}

initialize()
{
    unsigned long   physicaladdress;

    NIC_read_reg(&csr6);
    NIC_write_reg(&csr6,csr6.value&~(CSR6_SR|CSR6_ST));
    delay(10);
    InitializeTheTransmitRing (6);
    InitializeTheReceiveRing (6);
    NIC_write_reg(&csr0,CSR0_L_SWR);

```


4.4 CODING DIFFERENCE BETWEEN MX98713, MX98713A, MX98715 AND MX98725

4.4.1 SPEED SELECTION

Speed selection of MX98713 are controlled by internal NWay registers. All the MII management commands should have the following structure:

<PRE><ST><OP><PHYAD><REGAD><TA><DATA><IDLE>

For detailed programming example, please refer to MX98713 application note.

As for MX98713A, MX98715 and MX98725, Internal NWay registers are removed and protocol selection is controlled by Operation Mode Register (CSR6) and 10Base-T Control Register (CSR14)

| NWay Active | 100F | 100H | 10F | 10H | |
|-------------|------|------|-----|-----|---|
| CSR6_PS | 0 | 1 | 1 | 0 | 0 |
| CSR6_PCS | X | 1 | 1 | X | X |
| CSR6_FD | 1 | 1 | 0 | 1 | 0 |
| CSR14_ANE | 1 | 0 | 0 | 0 | 0 |

4.4.2 ELSE REGISTERS SETTING FOR DEVELOPING YOUR OWN DRIVER

There is an obvious change in setting the contents of CSR16 in comparison with MX98713. In MX98713, the offset 80h in IO space that is CSR16 must be set to "0x0f37XXXX" to bring this controller into normal operation mode before any initialization process can be started by driver. However, in MX98713A, MX98715 and MX98725, driver developers must set the CSR16 to be "0x0b3cXXXX".

In summary, the contents of CSR16 for Mxic 100Base NIC controllers should be set differently as follow:

```
MX98713 = 0x0f37XXXX
MX98713A = 0x0b3cXXXX
MX98715 = 0x0b3cXXXX
MX98725 = 0x0b3cXXXX
```

Meanwhile, you could directly access the Nway auto-negotiation status from CSR20. Detailed format please refer to MX98725 data sheet.

4.5 EEPROM ACCESSING

The following is a reference code for accessing the contents of EEPROM that stores ID information and node configuration for the MX98725.

```

/*****
 * Read all content from EEPROM
 *****/
eeprom_read()
{
    unsigned int i, address, eeval;
    char bit;
    for (address=0; address<64; address++){
        NIC_write_reg(&csr9,(unsigned long)0x04800);
        eeprom_serial_in(0);
        eeprom_serial_in(1); //command
        eeprom_serial_in(1);
        eeprom_serial_in(0);
        for(i=0; i<6; i++){ //address serial in
            bit = ((address>>(5-i)) & 0x01) ? 1:0;
            eeprom_serial_in(bit);
        }
        eeval=0;
        for(i=0; i<16; i++){ //dat serial out
            NIC_write_reg(&csr9,(unsigned long)0x04803);
            NIC_read_reg(&csr9);
            eeval += (((unsigned long)0x008 & csr9.value)>>3)<<(15-
i);

            NIC_write_reg(&csr9,(unsigned long)0x04801);
        }
        NIC_write_reg(&csr9,(unsigned long)0x04800);
        c46[address*2] = eeval & 0x0ff;
        c46[address*2+1] = (eeval >>8) & 0x0ff;
    }
}

/*****
 * Write a word to EEPROM
 *****/
eeprom_write(unsigned int address, unsigned int data)
{
    unsigned int i;
    char bit;
    eeprom_wen();
    NIC_write_reg(&csr9,(unsigned long)0x04800);
    eeprom_serial_in(0);
    eeprom_serial_in(1); //command
    eeprom_serial_in(0);
    eeprom_serial_in(1);

    for(i=0; i<6; i++){ //address serial in
        bit = ((address>>(5-i)) & 0x01) ? 1:0;

```

```

    eeprom_serial_in(bit);
}
for(i=0; i<16; i++){    //data serial in
    bit = ((data>>(15-i)) & 0x01) ? 1:0;
    eeprom_serial_in(bit);
}
NIC_write_reg(&csr9,(unsigned long)0x04800);
NIC_write_reg(&csr9,(unsigned long)0x04801);
i=0;
do{
    i++;
    NIC_read_reg(&csr9);
} while (!(csr9.value & 0x08) && (i<10000));
NIC_write_reg(&csr9,(unsigned long)0x04800);
if (i==10000) prstrng ("Writing EEPROM error !!");
eeprom_wds();
}

eeprom_wen()
{
    NIC_write_reg(&csr9,(unsigned long)0x04800);
    eeprom_serial_in(0);
    eeprom_serial_in(1);
    eeprom_serial_in(0);
    eeprom_serial_in(0);
    eeprom_serial_in(1);
    eeprom_serial_in(1);
    eeprom_serial_in(1);
    eeprom_serial_in(0);
    eeprom_serial_in(0);
    eeprom_serial_in(0);
    eeprom_serial_in(0);
    NIC_write_reg(&csr9,(unsigned long)0x04800);
}

eeprom_wds()
{
    NIC_write_reg(&csr9,(unsigned long)0x04800);
    eeprom_serial_in(0);
    eeprom_serial_in(1);
    eeprom_serial_in(0);
    eeprom_serial_in(0);
    eeprom_serial_in(0);
    eeprom_serial_in(0);
    eeprom_serial_in(0);
    eeprom_serial_in(0);
    eeprom_serial_in(0);
    eeprom_serial_in(0);
    eeprom_serial_in(0);
    eeprom_serial_in(0);
    eeprom_serial_in(0);
    NIC_write_reg(&csr9,(unsigned long)0x04800);
}

```

```

/*****
* Serial inject a bit to EEPROM
*****/

```

```

eeprom_serial_in(unsigned int bit2)
{
    NIC_write_reg(&csr9,(unsigned long)0x04800+4*bit2);
    NIC_write_reg(&csr9,(unsigned long)0x04803+4*bit2);
    NIC_write_reg(&csr9,(unsigned long)0x04801+4*bit2);
}

```

4.6 Flash ROM accessing

Following is an example code for accessing Macronix's flash ROM MX28F2000.

```

#define CYCLE1_ADDRESS (unsigned long)0x00005555
#define CYCLE2_ADDRESS (unsigned long)0x00002aaa

FlashWrite (unsigned long FlashAddress, unsigned char
FlashData)
{
    NIC_write_reg(&csr10, FlashAddress);
    NIC_write_reg(&csr9, (unsigned long)(0x00003000 |
FlashData));
}

unsigned char FlashRead (unsigned long FlashAddress)
{
    NIC_write_reg(&csr10, FlashAddress);
    NIC_write_reg(&csr9, (unsigned long)(0x00005000));
    NIC_read_reg(&csr9);
    return ((unsigned char)(0xff & csr9.value));
}

ResetToReadMode ()
{
    _disable();
    FlashWrite (CYCLE1_ADDRESS, (unsigned char) 0xff);
    FlashWrite (CYCLE1_ADDRESS, (unsigned char) 0xff);
    _enable();
}

unsigned char Read_ID_OK ()
{
    unsigned char manufactureID;
    unsigned char deviceID;

    ResetToReadMode ();

    _disable();
    FlashWrite (CYCLE2_ADDRESS, (unsigned char) 0x90);
    manufactureID = FlashRead (CYCLE2_ADDRESS);
    FlashWrite (CYCLE2_ADDRESS, (unsigned char) 0x90);
    deviceID = FlashRead (CYCLE2_ADDRESS+1);
    _enable();

    ResetToReadMode ();
    if ((manufactureID!=0xc2) | (deviceID!=0x2a)) return 0;
    else return 0xff;
}

```

```

SetUpByteWriteCmd (unsigned long wraddr, unsigned char
wrdata)
{
    unsigned char tmp;

```

```

_disable();
FlashWrite (wraddr, (unsigned char) 0x40);
FlashWrite (wraddr, wrdata);
_enable();
tmp = FlashRead (wraddr);
while (tmp != FlashRead(wraddr)) tmp=FlashRead(wraddr);
ResetToReadMode ();
}

ChipErase ()
{
    unsigned char tmp;

    _disable();
    FlashWrite (CYCLE1_ADDRESS, (unsigned char) 0x30);
    FlashWrite (CYCLE1_ADDRESS, (unsigned char) 0x30);
    _enable();

    delay100us ();
    tmp = FlashRead (CYCLE1_ADDRESS);
    while (tmp != FlashRead(CYCLE1_ADDRESS))
        tmp=FlashRead(CYCLE1_ADDRESS);
    ResetToReadMode ();
}

/*****/
main(argc,argv)
/*****/
int argc;
char *argv[];
{
    unsigned long i;

    // MX28F2000 manufactureID and DeviceID check
    if (!Read_ID_OK())
    {
        printf("\nRead ID failed !!!\n");
        exit(0);
    }

    // MX28F2000 erased
    ChipErase ();

    // MX28F2000 filled with all ' 0 '
    for (i=0; i<=0x3ffff; i++)
    {
        SetUpByteWriteCmd (i, 0);
        ResetToReadMode ();
    }
}

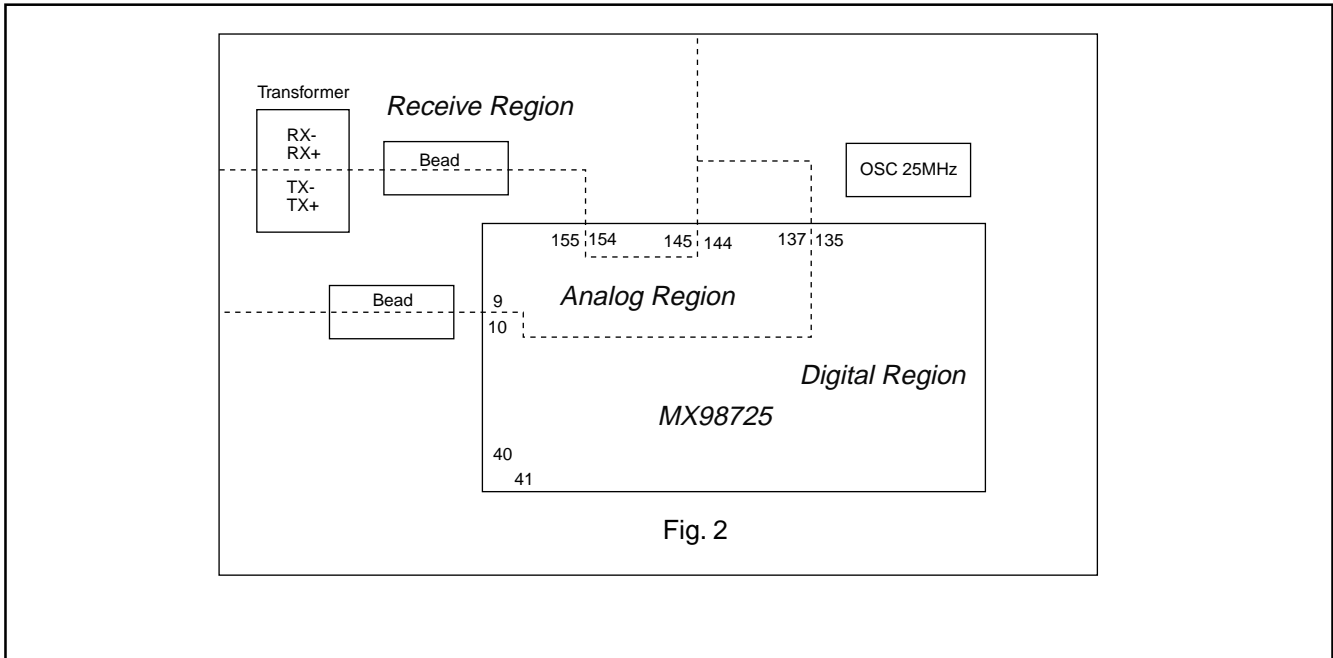
```

5. PCB LAYOUT RECOMMENDATIONS

The MX98725-based adapter board is strongly recommended to separate the power plane into 3 regions, i.e., digital, analog and receive region to isolate from digital noise and noise coupling between the transmitter and the receiver. These power pins in these three regions are shown in the table listed below. Each VDD pin also needs a 0.1uF capacitor located as close to the VDD pin as possible.

| Analog Region | Receive Region | Digital Region |
|---------------|----------------|----------------|
| 3. VDD | 147. VDD | Others |
| 4. GND | 148. GND | |
| 5. VDD | 145. VDD | |
| 6. GND | 146. GND | |
| 7. VDD | 151. GND | |
| 8. GND | 152. VDD | |
| 9. VDD | 153. GND | |
| 137. GND | 154. GND | |
| 138. VDD | | |
| 140. GND | | |
| 142. GND | | |
| 144. VDD | | |
| 143. GND | | |
| 155. VDD | | |
| 159. GND | | |

The power plane of designed PCB should be split into three regions. The below figure clearly describes an ideal power plane partition related to MX98725's pinout. To reduce noise incurred among power traces of these three regions, designers should allocate Ferrit Beads on the interface of +5V traces between digital and analog regions as well as between analog and receive regions. Such placement of Ferrit Beads implies that the power traces between digital and receive regions should be clearly isolated; all the power for receive region should be from analog region. All the traces and resistance/capacitance components for these pins of MX98725 should be located in each specified regions. As for placement of the 25MHz oscillator, it is recommended to be apart from receive and analog regions as far as possible to prevent from the impact of harmonic noise.



The MX98725 should be placed as close to the transformer as possible to reduce the length of layout traces and potential noise from coupling on RXIP/N and TXOP/N. The 100Ω resistor between RXIP and RXIN is suggested being located as close to the RXIP and RXIN pins of MX98725 as possible. The 49.9Ω pull up (VDD) resistors for TXOP and TXON pins should be placed as close to the TXOP and TXON pins of MX98725 as possible for impedance match purpose. The receive paths (traces of RXIP/N) need to be in parallel and have equal routing length on the component side of the PCB, and absolutely do not have any through hole on the receive paths to keep the signals clearance.

APPENDIX A: EEPROM FORMAT

| BYTE OFFSET (HEX) | DESCRIPTIONS |
|-------------------|--|
| 00-19 | Reserved |
| 1a | Magic Packet ID Byte1 |
| 1b | Magic Packet ID Byte0 |
| 1c | Magic Packet ID Byte3 |
| 1d | Magic Packet ID Byte2 |
| 1e-39 | Reserved |
| 3a | Magic Packet ID Byte5 |
| 3b | Magic Packet ID Byte4 |
| 3c-59 | Reserved |
| 5a | LSB of Sub-Device ID |
| 5b | MSB of Sub-Device ID |
| 5c | LSB of Sub-Vendor ID |
| 5d | MSB of Sub-Vendor ID |
| 5e-6f | Reserved |
| 70 | Network ID index: to indicate the starting address of Network ID in length of continuous 6 bytes. The content of this field could be in the range of 00-04h, or 10-14h, or 21-24h, or 31-34h |
| 71-76 | Reserved, and should be set to 0 |
| 77 | LED option: The content of this field will be read by driver for LED setting
Bit0: CSR9 Bit 28, LED0SEL
Bit1: CSR9 Bit 29, LED1SEL
Bit2: CSR9 Bit 30, LED2SEL
Bit3: CSR9 Bit 31, LED3SEL |
| 78-79 | Reserved, and should be set to 0 |
| 7a | LSB of Device ID |
| 7b | MSB of Device ID |
| 7c | LSB of Vendor ID |
| 7d | MSB of Vendor ID |
| 7e-7f | Reserved, and should be set to 0 |



APPENDIX B: MAGNETIC COMPONENTS

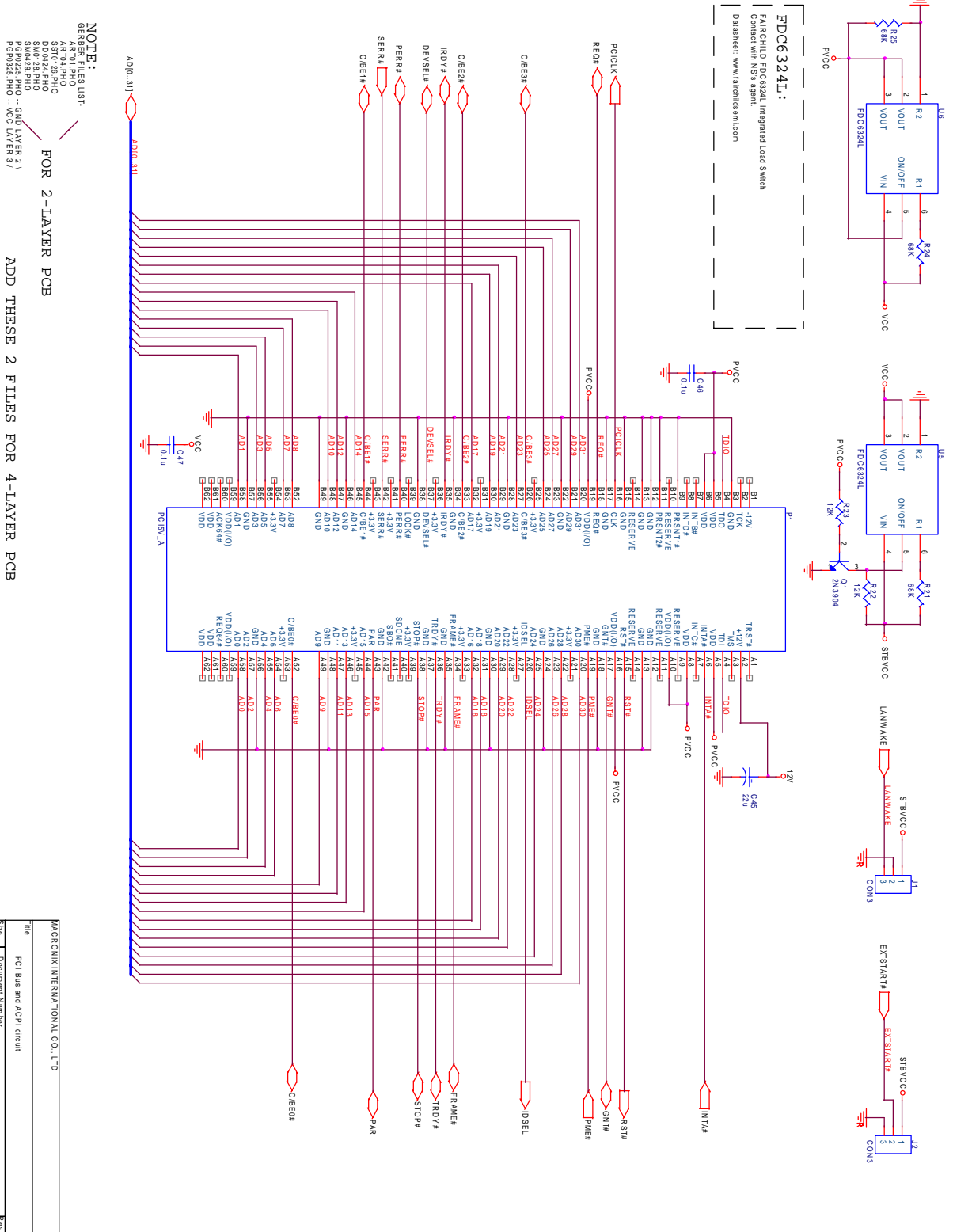
| 1 BASIC ELECTRICAL SPECIFICATION | | |
|-------------------------------------|--|-----|
| Turn Ratio | Transmit | 1:1 |
| | Receive | 1:1 |
| OCL | 350uH min measured between 0 and 70°C with a 0.1V rms, 100KHz signal at a DC bias between 0 and 8mA. | |
| LL | 0.4uH Max at >1MHz | |
| Cww | 18pF Max | |
| DCR | 0.9W Max per winding | |
| Isolation Resistance | not less than 1GW @ 2000V rms | |
| Isolation Voltage | 2000V rms Min @ 60Hz for 1 min | |
| Rise/Fall Time | 3ns Min 4ns Max | |
| Insertion Loss (100 KHz to 100 MHz) | -1.1 dB Max | |
| CMDR & DCMR (100 KHz to 80 MHz) | 38 dB Min | |
| Cross Talk (100KHz to 80 MHz) | -38 dB Max | |
| 2 REFERENCE VENDORS | | |
| Vendor | Part No | |
| Valor | ST6118 (PT4171S) | |
| PE | PE68515 | |
| BelFuse | S558-5999-15 | |
| Delta | LF8200 | |
| Taimic | HSIP-002 | |

**APPENDIX C: THE B.O.M. LIST OF MX98715 DEMO BOARD**

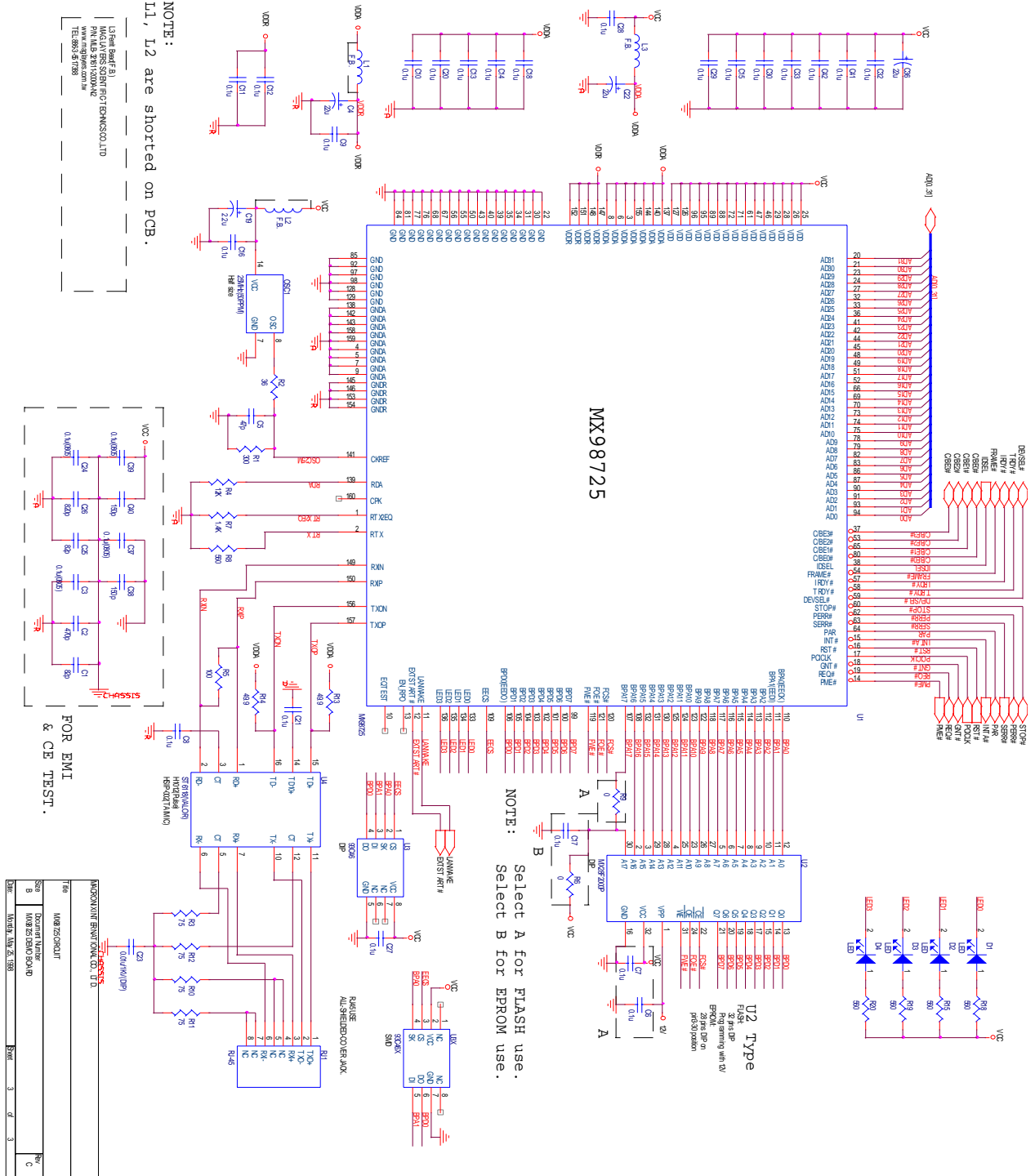
| ITEM | QUANTITY | REFERENCE | PART |
|------|----------|--|--|
| 1 | 2 | C1, C25 | 82p |
| 2 | 1 | C2 | 470p |
| 3 | 4 | C3, C24, C37, C39 | 0.1u (0805) |
| 4 | 4 | C4, C22, C36, C45 | 22u |
| 5 | 1 | C5 | 47p |
| 6 | 24 | C6, C7, C8, C9, C10, C11, C12, C13, C14,
C15, C16, C18, C20, C21, C27, C28, C29,
C30, C32, C33, C41, C42, C46, C47 | 0.1u (0603) |
| 7 | 1 | C19 | 2.2u |
| 8 | 1 | C23 | 0.01u/1KV (DIP) |
| 9 | 1 | C26 | 820p |
| 10 | 2 | C38, C40 | 150p |
| 11 | 4 | D1, D2, D3, D4 | LED |
| 12 | 2 | J1, J2 | CON3 |
| 13 | 1 | L3 | F.B. |
| 14 | 1 | OSC1 | 25MHz (50PPM) Half
size |
| 15 | 1 | Q1 | 2N3904 (SMD) |
| 16 | 1 | R2 | 36 |
| 17 | 4 | R3, R10, R11, R12 | 75 |
| 18 | 3 | R4, R22, R23 | 12K |
| 19 | 1 | R5 | 100 |
| 20 | 1 | R9 | 0 |
| 21 | 1 | R7 | 1.4K |
| 22 | 5 | R8, R15, R18, R18, R20 | 560 |
| 23 | 2 | R13, R14 | 49.9 |
| 24 | 3 | R21, R24, R25 | 68K |
| 25 | 1 | RJ1 | RJ-45 |
| 26 | 1 | U1 | MX98725 |
| 27 | 1 | U2 | MX28F2000P |
| 28 | 1 | U3 | 93C46 |
| 29 | 1 | U4 | ST6118 (VALOR),
H1012 (Pulse), HSIP-002
(TAIMIC) |
| 30 | 2 | U5, U6 | PDC6324L |

APPENDIX D: MX98725 APPLICATION SCHEMATIC CIRCUITS

D.1 PCI BUS INTERFACE



D.2 MX98725 AND FRONT-END CIRCUITS





REVISION HISTORY

| Revision No. | Description | Date |
|--------------|--|------------|
| 1.1 | To modify resistor R7 value from 1.5K Ω to 1.4K Ω P.2, P.11, P.13) | 07/10/1998 |



MX98725

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